

Key Features:

• Frequency range: 0.1 – 2GHz

• Insertion loss: 0.3dB

• Isolation: 45dB

Input/output standing wave : 1.2

Input P-0.3 : 46dBm
Switching time : 20ns
Control method : 0/-40V

• Chip dimensions: 1.6mm x 1.25mm x 0.1mm

• Applications: wireless communication, transceiver module, radio telecommunication etc.

Description:

AMT2301 chip is a reflection SPDT switch chip (MMIC), the design is based on Gallium Nitrate (GaN) HEMT process, with ground through metal via on the back technology. All chip products are 100% RF tested. The chip uses 0V, -40V level control, typical insertion loss 0.3dB, isolation 45dB, Input/Output VSWR 1.2, and switching time is 20ns.

Absolute Maximum Ratings

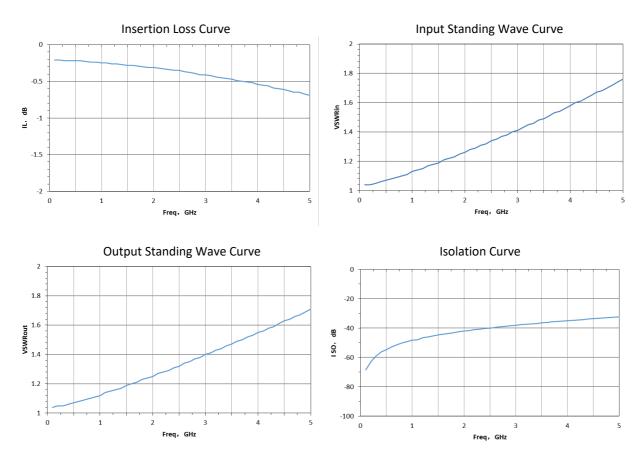
Symbol	Parameter	Value	Remark
V1, V2	Control Voltage	0.6V/-50V	
Pin	Input Power	48dBm	
Tm	Sintering Temperature	310 °C	30s, N ₂ protection
Tstg	Storage Temperature	-65 ~ +150 °C	

[1] Operation outside any of the Absolute Maximum Ratings may cause permanent device damage.

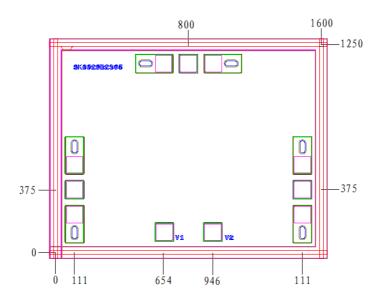
Electrical Characteristics (Ta = 25°C)

Symbol	Parameter	Value		Unit	
		Min	Typical	Max	
VSWRin	Input Standing Wave	-	1.2	-	
VSWRout	Output Standing Wave	-	1.2	-	
IL	Insertion Loss	-	0.3	-	dB
ISO	Isolation	-	45	-	dB

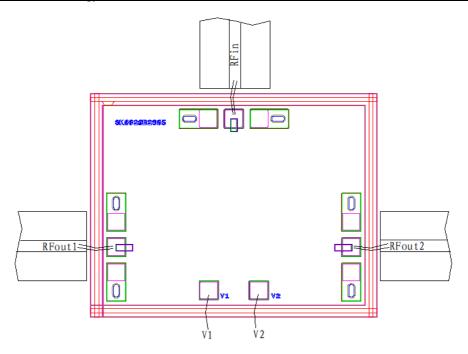
Typical Performance



Chip Dimension (Unit: µm)



Chip Layout Diagram



Pad Definition

Pad No.	Symbol	Function	Dimension
1	RF_in	RF signal input port, connecting to external 50Ω system, no need to add DC blocking capacitor.	100*100μm²
2	RF_out1	RF signal output port 1, connecting to external 50 $\!\Omega$ system, no need to add DC blocking capacitor.	100*100μm²
3	RF_out2	RF signal output port 2, connecting to external 50Ω system, no need to add DC blocking capacitor.	
4	V1	Supply control port, refer to the Truth Table for its control logic.	100*100μm²
5	V2	Supply control port, refer to the Truth Table for its control logic.	100*100μm²

Truth Table

	V1	V2
RF_in - RF_out1	-40V	0V
RF_in – RF_out2	0V	-40V

Please see Appendix A for details.